



DN0150ALP4 / DN0150BLP4

NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

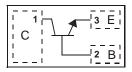
- Epitaxial Die Construction
- Ultra-Small Leadless Surface Mount Package
- Ultra Low Profile (0.4mm max)
- Complementary PNP Type Available (DP0150ALP4 / DP0150BLP4)
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q 101 Standards for High Reliability



Bottom View

Mechanical Data

- Case: DFN1006H4-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections Indicator: Collector Dot
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Ordering Information: See Page 3
- Marking Information: See Page 3
- Weight: 0.0008 grams (approximate)



Top View Device Schematic

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	60	V
Collector-Emitter Voltage	V_{CEO}	50	V
Emitter-Base Voltage	V _{EBO}	5	V
Collector Current – Continuous	Ic	100	mA
Peak Pulse Collector Current	I _{CM}	200	mA
Base Current	I _B	30	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	P _D	450	mW
Thermal Resistance, Junction to Ambient (Note 3)	$R_{ hetaJA}$	278	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage		V(BR)CBO	60	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage	(Note 4)	V(BR)CEO	50	_	_	V	$I_C = 1 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage		V(_{BR)EBO}	5	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector Cut-Off Current		I _{CBO}	_	_	0.1	μΑ	$V_{CB} = 60V, I_{E} = 0$
Emitter Cut-Off Current		I _{EBO}	_	_	0.1	μΑ	$V_{EB} = 5V, I_{C} = 0$
ON CHARACTERISTICS (Note 4)							
Collector-Emitter Saturation Voltage		V _{CE(SAT)}	_	0.10	0.25	V	$I_C = 100 \text{mA}, I_B = 10 \text{mA}$
DC Current Gain	DN0150ADJ		120	_	240		$V_{CF} = 6V$, $I_{C} = 2mA$
	DN0150BDJ	h _{FE}	200		400		VCE = OV, IC = ZIIIA
SMALL SIGNAL CHARACTERISTICS							
Transition Frequency		f⊤	60			MHz	$V_{CE} = 10V$, $I_E = -1mA$
Transition requeitey		11	00			IVII IZ	f = 30MHz
Output Capactiance		C _{ob}	_	1.3	_	pF	$V_{CB} = 10V, I_E = 0,$ f = 1MHz

Notes:

- 1. No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 3. Device mounted on FR-4 PCB with minimum recommended pad layout.
- 4. Measured under pulsed conditions. Pulse width = $300\mu s$. Duty cycle $\leq 2\%$

DODES

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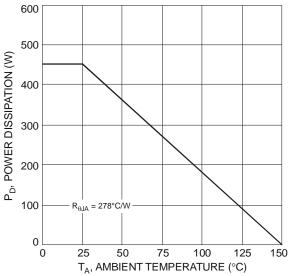
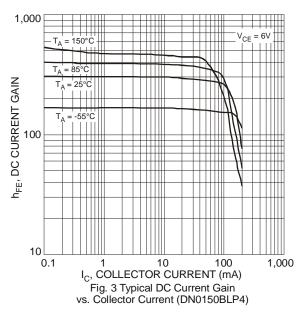
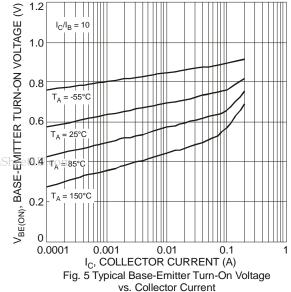


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 3)





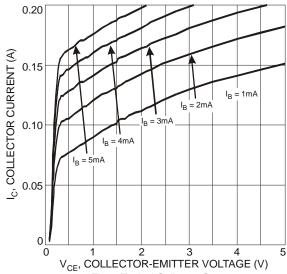


Fig. 2 Typical Collector Current vs. Collector-Emitter Voltage (DN0150BLP4)

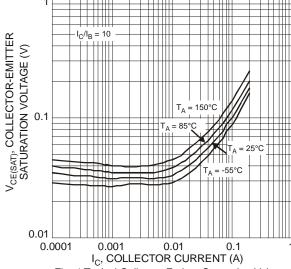


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

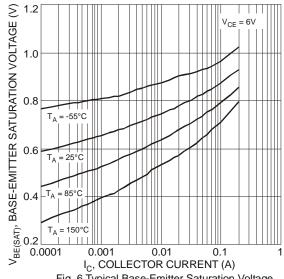
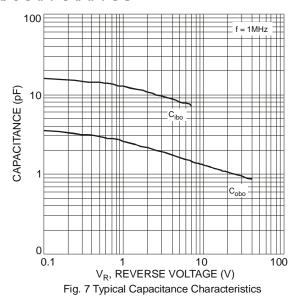


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

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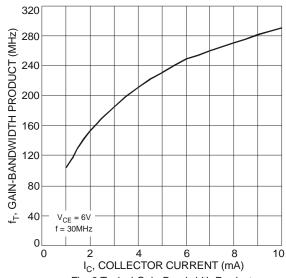


Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current

Ordering Information (Note 5)

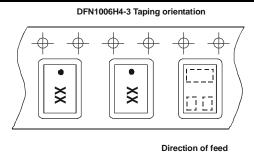
Ī	Device	Packaging	Shipping
	DN0150ALP4-7	DFN1006H4-3	3000/Tape & Reel
	DN0150BLP4-7	DFN1006H4-3	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

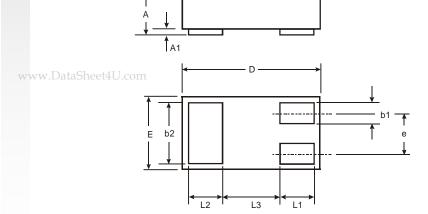
Marking Information

• xx

xx= Product Type Marking Code: T3 = DN0150ALP4 T4 = DN0150BLP4 Dot Denotes Collector Side



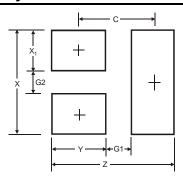
Package Outline Dimensions



DFN1006H4-3				
Dim	Min	Max	Тур	
A		0.40	_	
A1	0	0.05	0.02	
b1	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
ם	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
e		_	0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3		_	0.40	
All Dimensions in mm				



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Υ	0.4
С	0.7

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